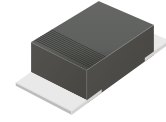


## CDBFN140-G Thru. CDBFN160-G

Voltage: 40 to 60 Volts

Current: 1.0 Amp

RoHS Device

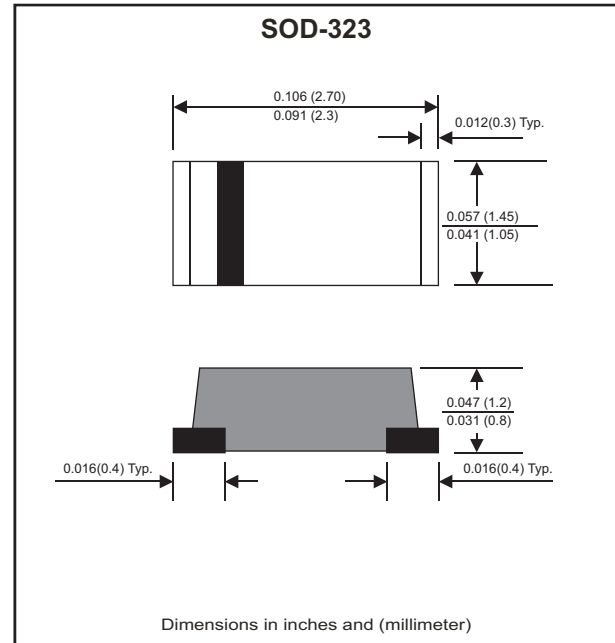


### Features

- Batch process design, excellent power dissipation offers better reverse leakage current.
- Low profile surface mounted application in order to optimize board space.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guard ring for overvoltage protection.
- Very tiny plastic SMD package.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

### Mechanical data

- Case: JEDEC SOD-323, Molded plastic
- Terminals: Solde plated, solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band.
- Mounting position: Any
- Weight: 0.008 grams (approx.).



### Circuit Diagram



### Maximum Ratings (at TA=25°C unless otherwise noted)

Parameter	Symbol	CDBFN 140-G	CDBFN 160-G	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>	40	60	V
Maximum RMS voltage	V <sub>RMS</sub>	28	42	V
Continuous reverse voltage	V <sub>R</sub>	40	60	V
Maximum forward voltage @I <sub>F</sub> =1.0A	V <sub>F</sub>	0.55	0.70	V
Forward rectified current	I <sub>O</sub>	1.0		A
Forward surge current, 8.3ms half sine wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	30		A
Maximum Reverse current	I <sub>R</sub>	0.5		mA
		10		
Typ. Thermal resistance, junction to ambient air	R <sub>θJA</sub>	90		°C/W
Typ. Diode junction capacitance (Note 1)	C <sub>J</sub>	120		pF
Operating junction temperature	T <sub>J</sub>	-55 to +125	-55 to +150	°C
Storage temperature	T <sub>STG</sub>	-65 to +175		°C

Note 1: f=1MHz and applied 4V DC reverse voltage.

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REV:G

## Ratings and Characteristic Curves(CDBFN140-G Thru CDBFN160-G)

Fig.1 - Typical Forward Current Derating Curve

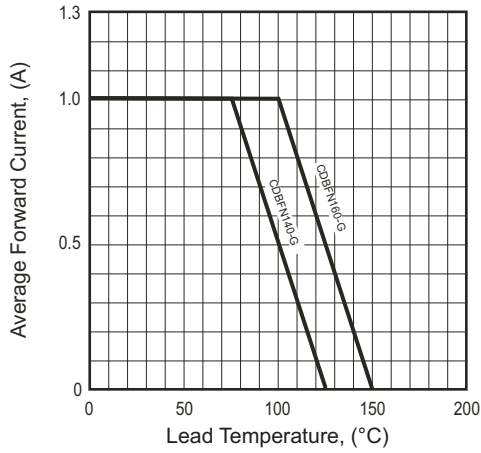


Fig.2 - Typical Forward Characteristics

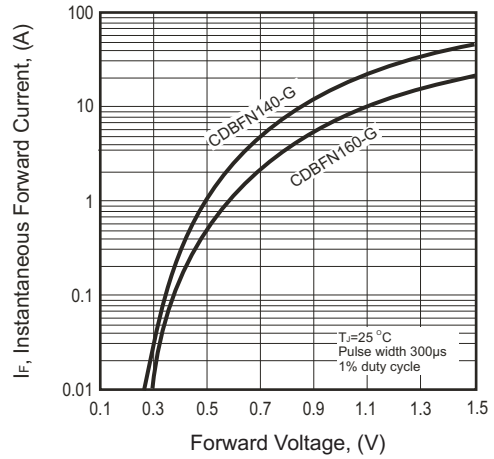


Fig.3 - Maximum Non-repetitive Forward Surge Current

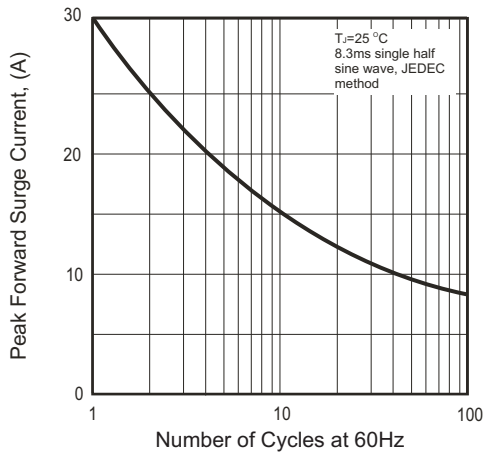


Fig.4 - Typical Junction Capacitance

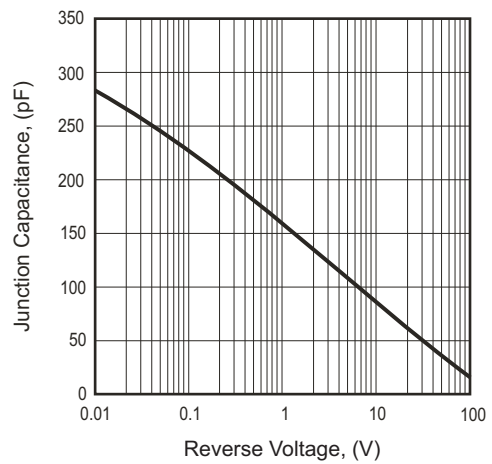
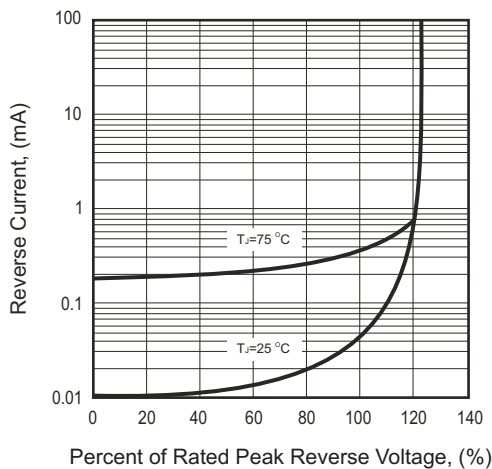
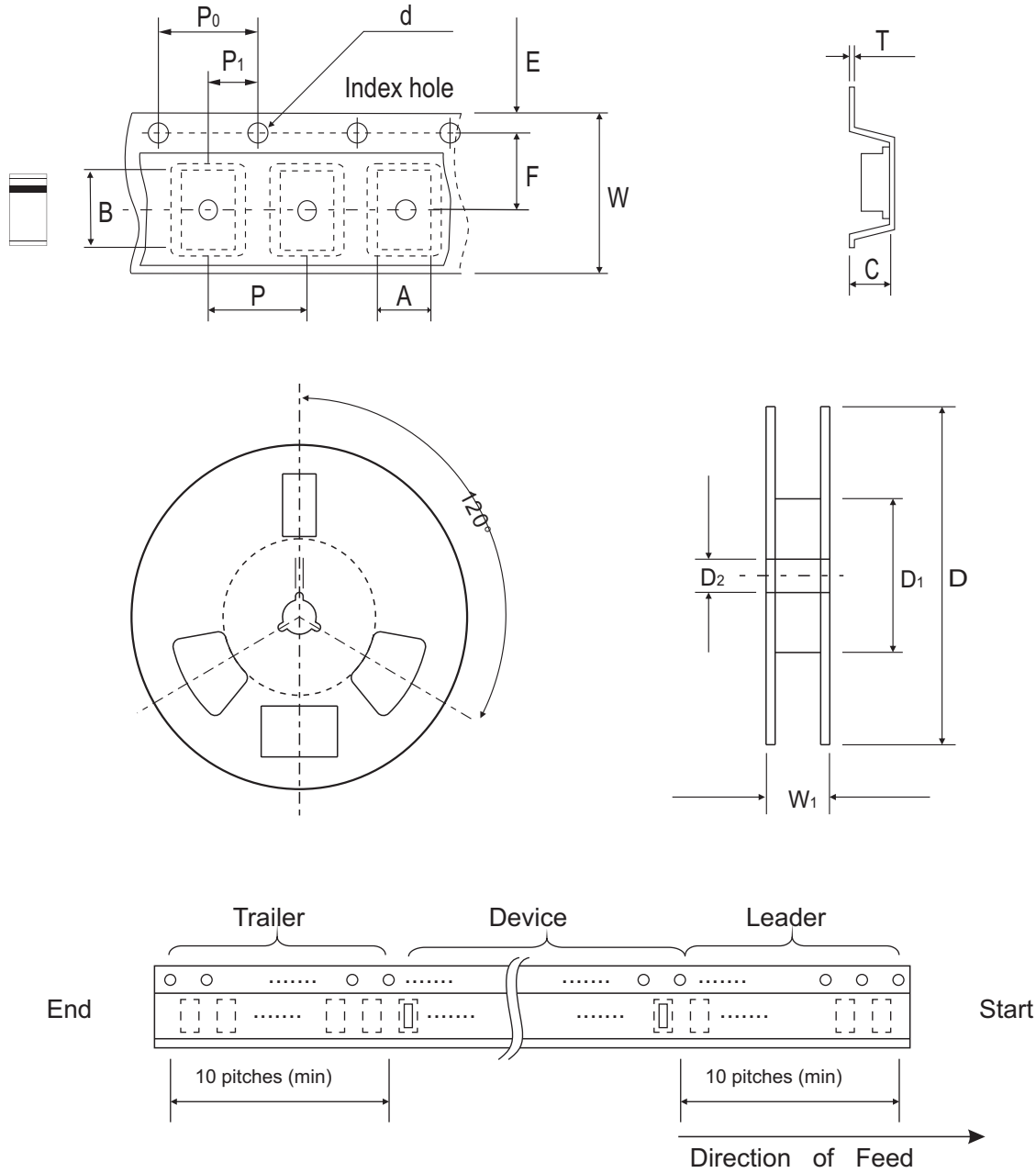


Fig.5 - Typical Reverse Characteristics



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## Reel Taping Specification



SOD-323	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	1.47 ± 0.10	2.95 ± 0.10	1.15 ± 0.10	1.50 ± 0.10	178 ± 1	62.0 MIN.	13.0 ± 0.20
	(inch)	0.057 ± 0.004	0.116 ± 0.004	0.045 ± 0.004	0.059 ± 0.004	7.008 ± 0.040	2.44 MIN.	0.512 ± 0.008

SOD-323	SYMBOL	E	F	P	P0	P1	W	W1
	(mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	8.00 ± 0.30	11.4 MAX.
	(inch)	0.069 ± 0.004	0.138 ± 0.002	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.002	0.315 ± 0.012	0.449 MAX

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## Marking Code

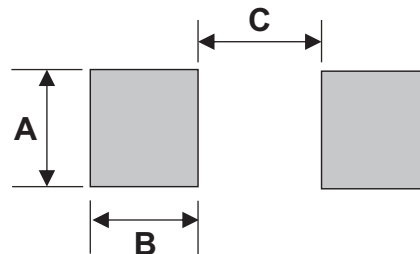
Part Number	Marking Code
CDBFN140-G	14
CDBFN160-G	16



XX=Product type marking code

## Suggested PAD Layout

SIZE	SOD-323	
	(mm)	(inch)
A	1.50	0.059
B	1.00	0.039
C	1.30	0.051



## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
SOD-323	3,000	7